EPISTAR

> Mechanical Specification:

- (1) Dimension
 - Chip size: 45 mil x 45 mil (1143 \pm 50 μm x 1143 \pm 50 μm)
 - Thickness: 5.9 mil (150 \pm 10 $\mu m)$
 - P bonding pad: 3.9 mil (100 \pm 10 $\mu m)$
 - N bonding pad: 3.9 mil (100 \pm 10 $\mu m)$

(2) Metallization

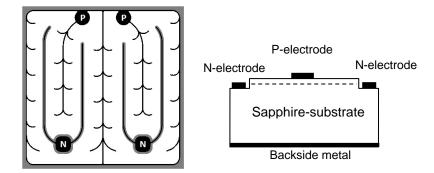
- Topside P electrode: Au alloy
- Topside N electrode: Au alloy
- Backside metal: Au alloy

Features:

- $\cdot \, {\rm High \ radiant \ flux}$
- Long operation life
- Lambertian radiation
- High anti-ESD level

Applications:

- UV air purifier
- Medical applications
- Curing



> Electro-optical Characteristics at 25°C: (1)

Parameter	Symbol		Condition	Min.	Тур.	Max.	Unit
	Vf1		lf = 10uA	1.6	-	-	V
Forward Voltage	Vf		lf = 350mA	-	3.2	3.4	V
Peak Wavelength ⁽²⁾	λр		lf = 350mA	395	-	415	nm
Spectra Half-width	Δλ		lf = 350mA	-	15	-	nm
Radiant Flux ⁽³⁾⁽⁴⁾	Po	A86	lf = 350mA	440	-	460	mW
		A87		460	-	480	
		A88		480	-	500	
		A89		500	-	520	

Note: (1) ESD protection during chip handling is recommended.

(2) Basically, the wavelength span is 20nm; however, customers' special requirements are also welcome.

(3) Radiant flux is determined by using an Ag-plated TO-can header without an encapsulant.

(4) Radiant flux measurement allows a tolerance of $\pm 15\%$.

ES-EAUVF45H InGaN F-series UV LED Chip

> Absolute Maximum Ratings:

Parameter	Symbol	Condition	Rating	Unit
Forward DC Current	lf	Ta = 25°C	≤ 700	mA
Junction Temperature	Тј	-	≤ 125	°C
Storage Temperature	Tstg	Chip	-40 ~ +85	°C
		Chip-on-tape/storage	5 ~ 35	°C
		Chip-on-tape/transportation	-20 ~ +65	°C
Temperature during Packaging	-	- 280(<10sec)		°C

Note: Maximum ratings are package dependent. The above maximum ratings were determined using a Metal Core Printed Circuit Board (MCPCB) without an encapsulant. Stresses in excess of the absolute maximum ratings such as forward current and junction temperature may cause damage to the LED.

> Characteristic Curves:

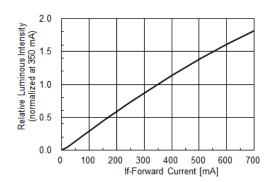


Fig.1 – Relative luminous Intensity vs. Forward Current

Fig.3 – Relative Intensity (@350mA) vs. Ambient Temperature

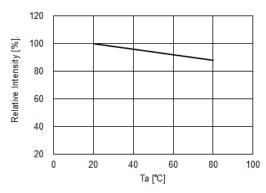


Fig.5 –Peak Wavelength (@350mA) vs. Ambient Temperature

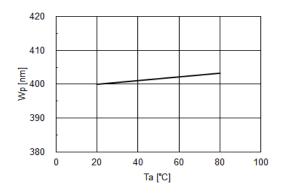


Fig.2 – Forward Current vs. Forward Voltage

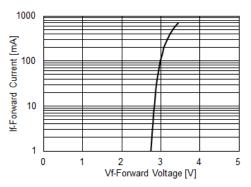


Fig.4 – Forward Voltage (@350mA) vs. Ambient Temperature

